



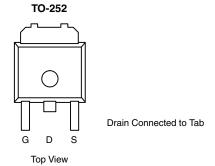
N-Channel 30 V (D-S) MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A) ^a			
30	0.0120 at V _{GS} = 10 V	17.5			
30	0.0175 at V _{GS} = 4.5 V	14.5			

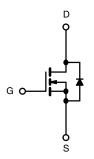
FEATURES

- TrenchFET® Power MOSFET
- 100 % R_g and UIS Tested
- Compliant to RoHS Directive 2002/95/EC





Ordering Information: SUD50N03-12P-E3 (Lead (PB) free)



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS $(T_A =$	25 °C, unless othe	rwise noted)			
Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	V _{DS}	30	V		
Gate-Source Voltage	V _{GS}	± 20	□		
Outliness Durin Oursell	T _A = 25 °C	I_	17.5		
Continuous Drain Current ^a	T _A = 100 °C	I _D	12.4		
Pulsed Drain Current	I _{DM}	40	Α		
Continuous Source Current (Diode Conduction) ^a	I _S	5			
Avalanche Current	L = 0.1 mH		30	7	
Single Pulse Avalanche Energy	L = 0.1 IIII	E _{AS}	45	mJ	
Maximum Dawar Dissination	T _C = 25 °C	В	46.8	w	
Maximum Power Dissipation	T _A = 25 °C	P _D	6.5 ^a] vv	
Operating Junction and Storage Temperature Range	•	T _J , T _{stg}	- 55 to 175	°C	

THERMAL RESISTANCE RATINGS							
Parameter		Symbol	Typical	Maximum	Unit		
Mariana Instituta In Ambianta	t ≤ 10 s	R _{thJA}	18	23	°C/W		
Maximum Junction-to-Ambient ^a	Steady State	□thJA	40	50			
Maximum Junction-to-Case		R _{thJC}	2.6	3.2			

a. Surface mounted on FR4 board, $t \le 10 \text{ s.}$

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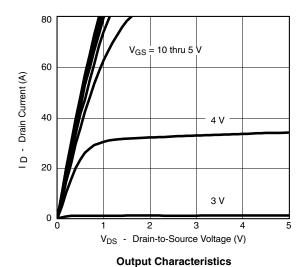
SPECIFICATIONS (T _J = 25 °C, unless otherwise noted)						
Parameter	Symbol	Test Conditions	Min .	Typ. ^a	Max.	Unit
Static						
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_{D} = 250 \mu\text{A}$	30			V
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \mu A$	1		3	V
Gate-Body Leakage	I_{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA
Zero Gate Voltage Drain Current	l	$V_{DS} = 24 \text{ V}, V_{GS} = 0 \text{ V}$			1	
Zero Gate voltage Drain Current	I _{DSS}	$V_{DS} = 24 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 125 \text{ °C}$			50	μΑ
On-State Drain Current ^b	I _{D(on)}	$V_{DS} = 5 \text{ V}, V_{GS} = 10 \text{ V}$	40			Α
		$V_{GS} = 10 \text{ V}, I_D = 20 \text{ A}$		0.0100	0.0120	
Drain-Source On-State Resistance ^b	R _{DS(on)}	V _{GS} = 10 V, I _D = 20 A, T _J = 125 °C			0.0170	Ω
		$V_{GS} = 4.5 \text{ V}, I_D = 15 \text{ A}$		0.0138	0.0175	
Forward Transconductance ^b	9 _{fs}	$V_{DS} = 15 \text{ V}, I_{D} = 20 \text{ A}$	15			S
Dynamic ^a						
Input Capacitance	C _{iss}			1600		pF
Output Capacitance	C _{oss}	$V_{GS} = 0 \text{ V}, V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$		285		
Reverse Transfer Capacitance	C _{rss}			140		
Total Gate Charge ^c	Q_g			28	42	
Gate-Source Charge ^c	$V_{DS} = 15 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 50 \text{ A}$		6		nC	
Gate-Drain Charge ^c	Q_{gd}			5		
Gate Resistance	R_{g}	f = 1 MHz	0.3	1.5	3.0	Ω
Turn-On Delay Time ^c	t _{d(on)}			9	15	
Rise Time ^c	t _r	V_{DD} = 15 V, R_L = 0.3 Ω		15	25	ne
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong 50 \text{ A}, V_{GEN} = 10 \text{ V}, R_G = 2.5 \Omega$		20	30	ns
Fall Time ^c	t _f			12	20	
Source-Drain Diode Ratings and Characteristics (T _C = 25 °C)						
Pulsed Current	I _{SM}				100	Α
Diode Forward Voltage ^b	V_{SD}	I _F = 40 A, V _{GS} = 0 V		1.2	1.5	V
Source-Drain Reverse Recovery Time	t _{rr}	I _F = 50 A, dI/dt = 100 A/μs		25	70	ns

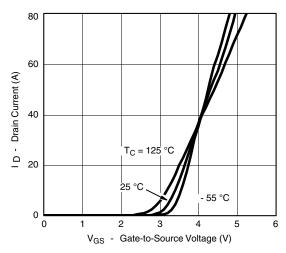
Notes:

- a. Guaranteed by design, not subject to production testing.
- b. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

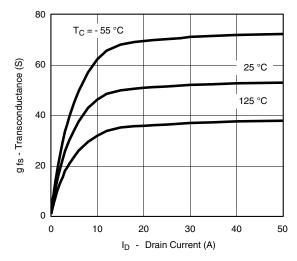
TYPICAL CHARACTERISTICS (25 °C unless noted)



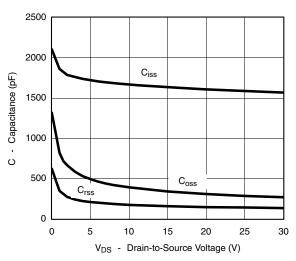




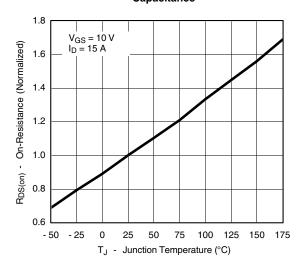
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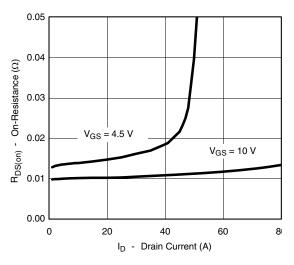
Transconductance



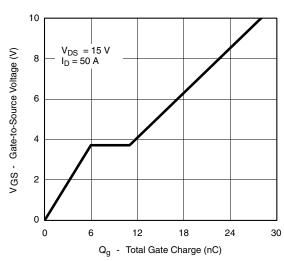
Capacitance



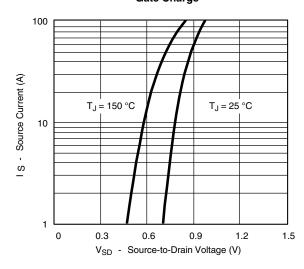
On-Resistance vs. Junction Temperature



On-Resistance vs. Drain Current



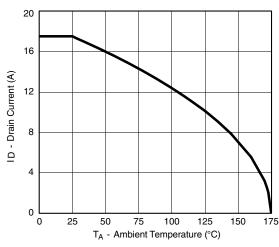
Gate Charge

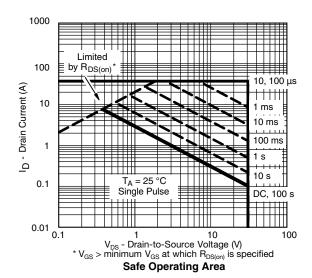


Source-Drain Diode Forward Voltage

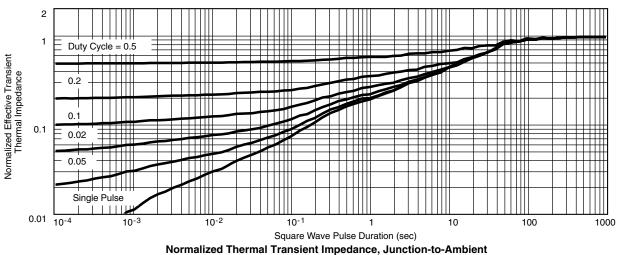
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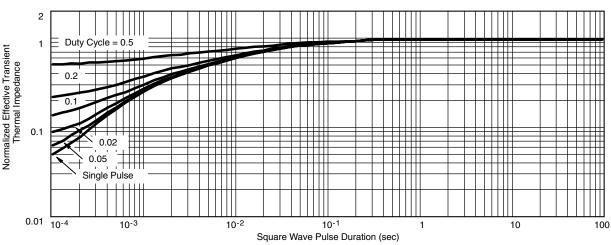
THERMAL RATINGS





Maximum Drain Current vs. Ambient Temperature





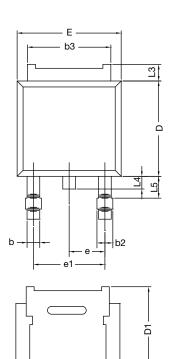
Normalized Thermal Transient Impedance, Junction-to-Case

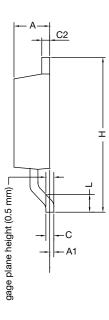
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TO-252AA Case Outline





	MILLIMETERS		INCHES		
DIM.	MIN.	MAX.	MIN.	MAX.	
Α	2.18	2.38	0.086	0.094	
A1	-	0.127	-	0.005	
b	0.64	0.88	0.025	0.035	
b2	0.76	1.14	0.030	0.045	
b3	4.95	5.46	0.195	0.215	
С	0.46	0.61	0.018	0.024	
C2	0.46	0.89	0.018	0.035	
D	5.97	6.22	0.235	0.245	
D1	4.10	-	0.161	-	
Е	6.35	6.73	0.250	0.265	
E1	4.32	-	0.170	-	
Н	9.40	10.41	0.370	0.410	
е	2.28 BSC		0.090 BSC		
e1	4.56	BSC	0.180	BSC	
L	1.40	1.78	0.055	0.070	
L3	0.89	1.27	0.035	0.050	
L4	-	1.02	-	0.040	
L5	1.01	1.52	0.040	0.060	
ECN: T16-0236-Rev. P, 16-May-16					

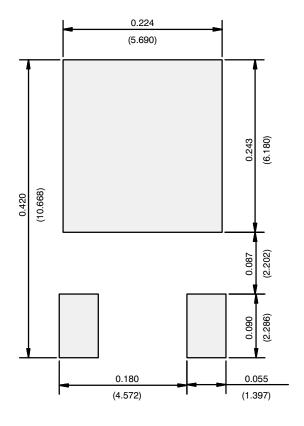
DWG: 5347

Notes

• Dimension L3 is for reference only.



RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)

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